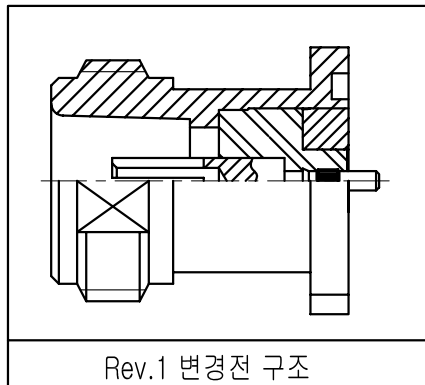
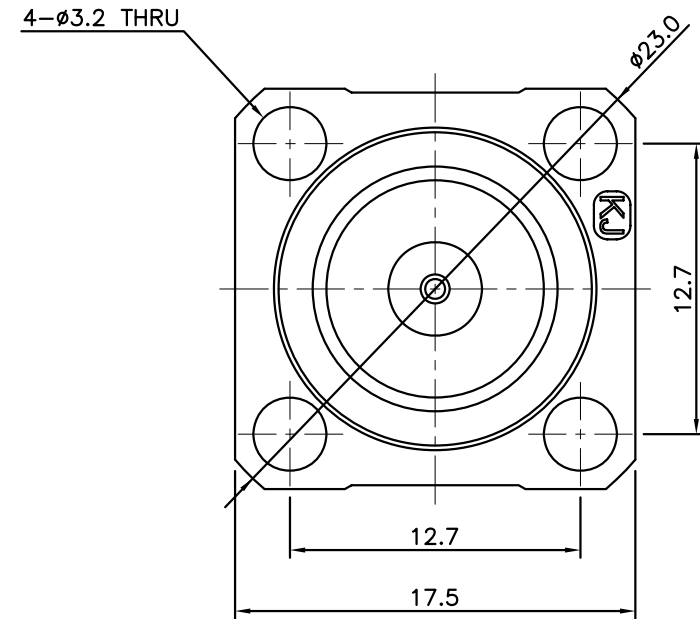
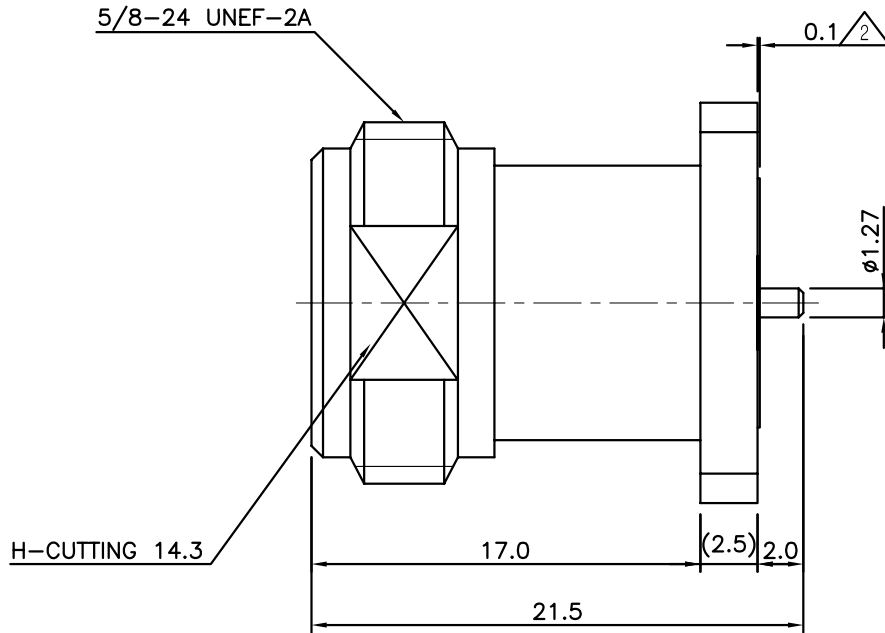


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2018.09.20.
1	[설변No.202012-0002] O-RING 빠짐 개선 안착부 금형수정	I.C.KIM		2020.12.07.
2	[설변No.202101-0003] O-RING 빠짐 개선 안착부 0.1mm Ground Boss 추가	S.Y.EUN	I.C.KIM	2021.01.20.



2	1	4	RING	1	MBsBD C3604BD-F	Nickel Plate	DSR01097-5/3 DSR01097-5/2 DSR01097-5/1
		3	INSULATOR	1	TEFLON		DIN02813-N/2
		2	CONTACT	1	BeCu C17300	Gold Plate	DCT03741-5/2
	1	1	BODY	1	ZnDC	Nickel Plate (3~4μm)	DBD02992-5/3 DBD02992-5/1
		NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2021. 01. 20.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM		
	±0.2				
MATERIAL	±1°	CHECKED BY	TITLE N50 SOLDER END JS-4H		

FINISH	_____	DRAWN BY	A4		
	_____	S.Y.EUN			
		SCALE	UNIT	DWG NO. CN03958-7/6	
		3/1	mm		
				SHEET 1 of 1	